Product Details for 146895 -



146895 -1

.4mm, .5mm, .6mm, .8mm, 1mm, Fine Pitch, Surface Mount, Stacking Bd Connectors

5 of 6 RoHS/ELV Compliant (Find RoHS Compliant Alternates/Compliance Statement)

Product Highlights:

- ? Receptacle
- ? Family Name = Free Height
- 2 1.00 mm Centerline
- ? Number of Positions = 64
- ? In -Line Contact Layout

View all Features

Quick Links

Check Pricing &
Availability
Search for Tooling
View Mating
Products (6)
Product Feature
Selector
Contact Us About
This Product

Documentation & Additional Information

Product Drawings:

? RECEPTACLE ASSY, W/ VACUUM COVER, 1.0mm FH(IEEE 1386... (PDF, English)

Catalog Pages/Data Sheets:

None Available

Product Specifications:

? None Available

Application Specifications:

? None Available

Instruction Sheets:

? None Available

CAD Files: (CAD Format & Compression Information

- ? 3D Model (STEP, Version H)
- ? <u>3D Model</u> (IGES, Version H)
- ? 2D Drawing (DXF, Version H)

List all Documents

Additional Information:

-to-Bd

Product Line Information

Additional Product Images:

? Product Photo

Related Products:

- ? Tooling
- ? Mating Products (6)

Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- ? Product Type = Receptacle
- ? Number of Positions = 64
- ? PCB Mount Angle = Vertical
- ? Keyed = No
- ? Comment = IEEE 1386 Mezzanine Connector.

Body Related Features:

- ? Centerline (mm [in]) = 1.00 [0.039]
- Board -to -Board Stack Height (mm [in]) = 13.00 [0.512]
- ? Locating Posts = With
- ? Vacuum Cover = With
- ? Number of Rows = Dual

Contact Related Features:

- ? Family Name = Free Height
- ? Contact Layout = In -Line
- ? Contact Material = Copper Alloy
- ? Contact Mating Area Plating = Gold (30)
- Contact Termination Area Plating = Tin -Lead over Nickel

Housing Related Features:

- ? Housing Color = Black
- ? Housing Material = High Temperature Thermoplastic
- ? Housing Flammability Rating = UL 94V -0
- ? Housing Material Temperature = High

Industry Standards:

- ? RoHS/ELV Compliance = ELV compliant, 5 of 6 Compliant
- Page 2 Lead Free Solder Processes = Wave solder capable to 240°C, Wave solder capable to 260°C, Wave solder capable to 265°C, Reflow solder capable to 245°C, Reflow solder capable to 260°C, Pin -in-Paste capable to 245°C, Pin in-Paste capable to 260°C

Packaging Related Features:

Packaging Method = Tape & Reel

Other:

? Brand = AMP

 Languages
 : English
 Deutsch
 Español
 Português (do Brasil)
 ???????
 Italiano
 ????
 (??)
 ??
 (??)
 ??
 ???

 Country Sites
 : China
 Japan